

N-Channel Power MOSFET

Description

The XR46000 is a silicon N-channel enhanced power MOSFET. With low conduction loss, good switching performance and high avalanche energy, it is suitable for various power supply system, especially for AC step driving application for LED lighting.

The package type is SOT-223, which comply with the RoHS standard.

Key Parameters

V _{DSS}	600V
ID	1.5A
$P_D \; (T_C = 25^\circC)$	20W
R _{DS,ON,typ}	7.0Ω

Equivalent Circuit



Figure 1. Equivalent Cirucit

FEATURES

- Fast switching
- ESD improved capability
- Low gate charge (Typ. 7.5nC)
- Low reverse transfer capacitance (Typ. 5.0pF)

APPLICATIONS

- LED lighting applications
 - Downlight
- High bay
- Specialty
- Architectural

Pin Configuration



SOT-223, Top View

Absolute Maximum Ratings

Stresses beyond the limits listed below may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

$T_C = 25^{\circ}C$ unless otherwise noted.

V _{DSS} drain-to-source voltage600V
I_D continuous drain current (T_C = 25°C) 1.5A
I_D continuous drain current (T_C = 100°C)0.85A
I _{DM} pulsed drain current6A
V_{GS} gate-to-source voltage\pm 30V
P_D power dissipation (T_C = 25°C)20W
P_D derating factor above $25^\circ C$ 0.16W/°C
T_{STORAGE} storage temperature range65°C to 150°C
E_{AS} single pulse avalanche energy80mJ
NOTE: Unless otherwise noted, all tests are pulsed tests at the specified temperature,

Unless otherwise noted, all tests are pulsed tests at the specified temperature therefore: $T_J = T_C = T_A$.

Operating Conditions

T _J operating junction temperature 150°	С
T _A operating ambient temperature40°C to 85°	С

Electrical Characteristics

 $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF Charac	cteristic					
BV _{DSS}	Drain to source breakdown voltage	$V_{GS} = 0V, I_D = 250\mu A$				V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown voltage temperature coefficient	I _D = 250μA, reference 25°C		0.71		V/°C
I _{DSS}		$V_{DS} = 600V, V_{GS} = 0V, T_A = 25^{\circ}C$	25			
	Drain to source leakage current	$V_{DS} = 600V, V_{GS} = 0V, T_A = 125^{\circ}C$			250	μΑ
I _{GSS(F)}	Gate to source forward leakage	V _{GS} = 30V			12	
I _{GSS(R)}	Gate to source reverse leakage	V _{GS} = -28V			μA -12	μA
ON Charact	teristic (pulse width tp \leq 380µs, $\delta \leq$ 2%)	I		1	<u> </u>	
R _{DS(ON)}	Drain to source on-resistance	V _{GS} = 10V, I _D = 0.75A		7.0	8.0	Ω
V _{GS(TH)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0		4.0	V
Dynamic Ch	haracteristic				1	
9fs	Forward transconductance	$V_{DS} = 15V, I_D = 0.75A$		1.0		s
C _{iss}	Input capacitance			170		
C _{oss}	Output capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz		27		pF
C _{rss}	Reverse transfer capacitance			5		
Resistive Sv	witching Characteristic				1	
t _{d(ON)}	Turn-on delay time			8		
t _r	Rise time] I _D = 1.5A, V _{DD} = 300V, V _{GS} = 10V,		30		
t _{d(OFF)}	Turn-off delay time	$R_{G} = 4.7\Omega$		22		ns .
t _f	Fall time			55		
Qg	Total gate charge			7.5		
Q _{gs}	Gate to source charge	I _D = 1.5A, V _{DD} = 480V, V _{GS} = 10V		1.7		nC
Q _{gd}	Gate to drain "Miller" charge			4.0		1
Source-Drai	in Diode Characteristics (pulse width tp \leq	380us, δ ≤ 2%)	1	1	<u> </u>	
I _S	Continuous source current (body diode)				1.5	A
I _{SM}	Maximun source current (body diode)				6.0	
V _{SD}	Diode forward voltage	I _S = 1.5A, V _{GS} =0V			1.5	V
T _{rr}	Reverse recovery time	-		530		ns
Q _{rr}	Reverse recovery charge	$I_D = 1.5A, T_J = 25^{\circ}C, dI_F/dt = 100A/\mu s, V_{GS} = 0V$		1100		nC
I _{RRM}	Reverse recovery current			4.4		А



Typical Performance Characteristics



Figure 2. Safe Operating Area



Figure 3. Typical Drain-to-Source ON Resistance vs. Gate Voltage and Drain Current





Package Description

Top View





Front View

Side View

3 Pin S	3 Pin SOT-223 JEDEC TO-261 Variation AA						
SYMBOLS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)			
	MIN	NOM	MAX	MIN	NOM	MAX	
A	—	—	1.80	—	—	0.071	
A1	0.02	_	0.10	0.001	—	0.004	
A2	1.50	1.60	1.70	0.060	0.063	0.067	
b	0.66	0.76	0.84	0.026	0.030	0.033	
b2	2.90	3.00	3.10	0.114	0.118	0.122	
с	0.23	0.30	0.35	0.010	0.012	0.014	
D	6.30	6.50	6.70	0.248	0.256	0.264	
E	6.70	7.00	7.30	0.264	0.276	0.287	
E1	3.30	3.50	3.70	0.130	0.138	0.146	
e	2.30 BSC			C).091 B	SC	
e1	4.60 BSC		0).182 B	SC		
L	0.75			0.030			
L2	0.25 BSC			0	.010 BS	SC	
θ	0°	_	10°	0°	—	10°	
N	3				3		



Ordering Information

Part Number	Operating Temperature Range	Environmental Rating	Package	Packaging Method	
XR46000ESE			SOT-223	Bulk	
XR46000ESETR	-40°C ≤ T _J ≤ 150°C	RoHS compliant and Green ⁽¹⁾	SOT-223	Tape and reel	
XR46000ECF			Dice	Wafer	

NOTE:

1. Visit <u>www.exar.com</u> for more information.

Revision History

Revision	Date	Description
1A	Aug 2016	Initial release



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